



# TX20N15A4L

## Silicon N-Channel Power MOSFET

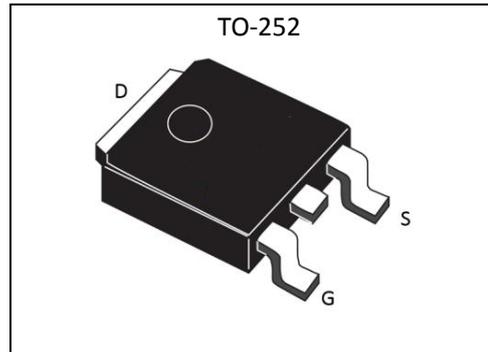
### General Description :

The TX20N15A4L uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications. The package form is TO-252, which accords with the RoHS standard.

$V_{DSS}$	150	V
$I_D$	20	A
$P_D$	90	W
$R_{DS(ON)type}$	62	$m\Omega$

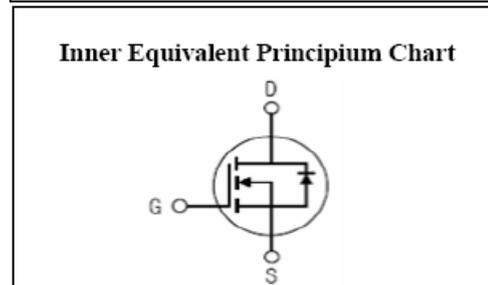
### Features :

- $R_{DS(ON)} < 75m\Omega$  @  $V_{GS}=10V$  (Typ62m $\Omega$ )
- High density cell design for ultra low  $R_{dson}$
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation



### Applications :

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



### Absolute ( $T_c= 25^\circ C$ unless otherwise specified ) :

Symbol	Parameter	Rating	Units
$V_{DSS}$	Drain-to-Source Voltage	150	V
$I_D$	Continuous Drain Current	20	A
$I_{DM}$	Pulsed Drain Current	40	A
$V_{GS}$	Gate-to-Source Voltage	$\pm 20$	V
$P_D$	Power Dissipation	90	W
$E_{AS}$	Single pulse avalanche energy <sup>a5</sup>	80	mJ
$T_J, T_{stg}$	Operating Junction and Storage Temperature Range	175 , -55 to 175	$^\circ C$



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**Electrical Characteristics** (  $T_c = 25^\circ\text{C}$  unless otherwise specified ) :

OFF Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$V_{DSS}$	Drain to Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	150	--	--	V
$I_{DSS}$	Drain to Source Leakage Current	$V_{DS}=150V, V_{GS}=0V, T_a=25^\circ\text{C}$	--	--	1.0	$\mu A$
$I_{GSS(F)}$	Gate to Source Forward Leakage	$V_{GS}=+20V$	--	--	0.1	$\mu A$
$I_{GSS(R)}$	Gate to Source Reverse Leakage	$V_{GS}=-20V$	--	--	-0.1	$\mu A$

ON Characteristics <sup>a3</sup>						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$R_{DS(ON)}$	Drain-to-Source On-Resistance	$V_{GS}=10V, I_D=10A$	--	62	75	$m\Omega$
$R_{DS(ON)}$	Drain-to-Source On-Resistance	$V_{GS}=4.5V, I_D=10A$	--	65	80	$m\Omega$
$R_{DS(ON)}$	Drain-to-Source On-Resistance	$V_{GS}=2.5V, I_D=10A$	--	75	100	$m\Omega$
$V_{GS(TH)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	0.5	--	1.5	V

Pulse width  $t_p \leq 380\mu s, \delta \leq 2\%$

Dynamic Characteristics <sup>a4</sup>						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$g_{fs}$	Forward Transconductance	$V_{DS}=5V, I_D=10A$	--	20	--	S
$C_{iss}$	Input Capacitance	$V_{GS}=0V, V_{DS}=75V$ $f=1.0\text{MHz}$	--	2500	--	pF
$C_{oss}$	Output Capacitance		--	150	--	
$C_{rss}$	Reverse Transfer Capacitance		--	54	--	

Resistive Switching Characteristics <sup>a4</sup>						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD}=75V, R_L=5\Omega$ $V_{GS}=10V, R_G=3\Omega$	--	23	--	ns
$t_r$	Rise Time		--	11	--	
$t_{d(OFF)}$	Turn-Off Delay Time		--	26	--	
$t_f$	Fall Time		--	11	--	
$Q_g$	Total Gate Charge	$V_{DD}=75V, I_D=10A$ $V_{GS}=10V$	--	60	--	nC
$Q_{gs}$	Gate to Source Charge		--	7.5	--	
$Q_{gd}$	Gate to Drain ( "Miller" ) Charge		--	17	--	



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Source-Drain Diode Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$I_S$	Continuous Source Current <sup>a2</sup> (Body Diode)		--	--	20	A
$V_{SD}$	Diode Forward Voltage <sup>a3</sup>	$I_S=20A, V_{GS}=0V$	--	--	1.2	V

Symbol	Parameter	Typ.	Units
$R_{\theta JC}$	Junction-to-Case <sup>a2</sup>	1.7	°C/W

<sup>a1</sup> : Repetitive Rating: Pulse width limited by maximum junction temperature.

<sup>a2</sup> : Surface Mounted on FR4 Board,  $t \leq 10\text{sec}$ .

<sup>a3</sup> : Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

<sup>a4</sup> : Guaranteed by design, not subject to production

<sup>a5</sup> : EAS condition :  $T_j=25^\circ\text{C}, V_{DD}=50V, V_G=10V, L=0.5\text{mH}, R_g=25\Omega$

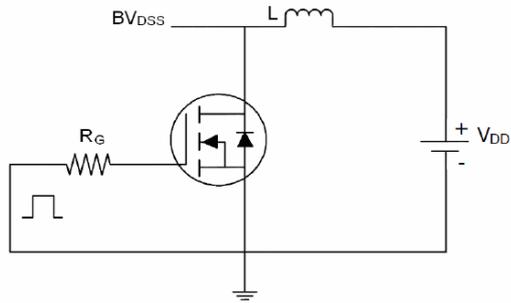
Test circuit



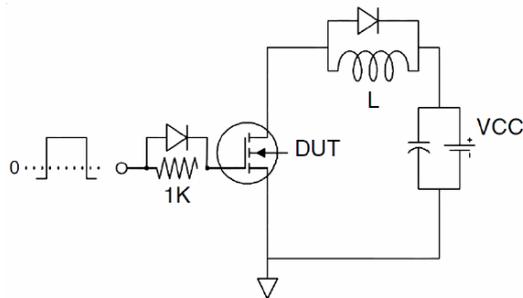
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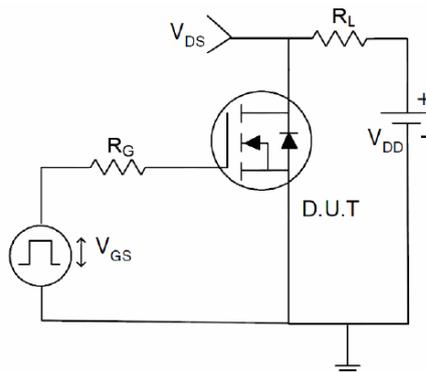
### 1) EAS test Circuit



### 2) Gate charge test Circuit



### 3) Switch Time Test Circuit



### Characteristics Curve :



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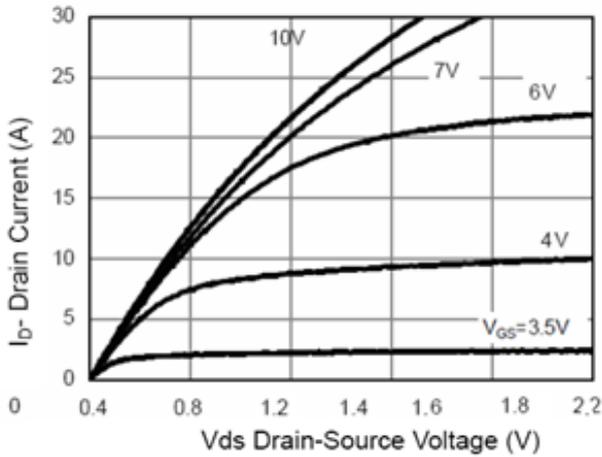


Figure 1 Output Characteristics

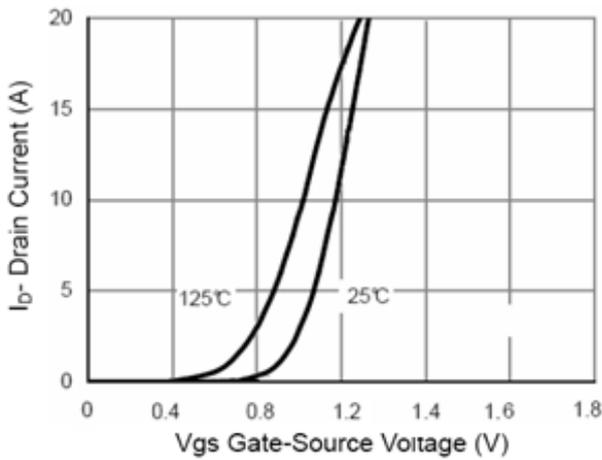


Figure 2 Transfer Characteristics

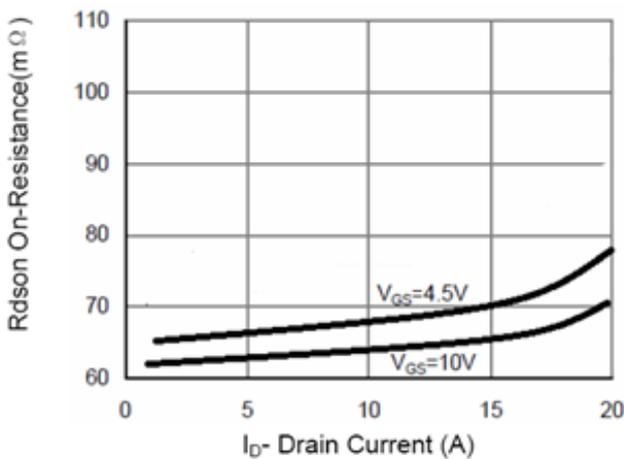


Figure 3 Rdson- Drain Current

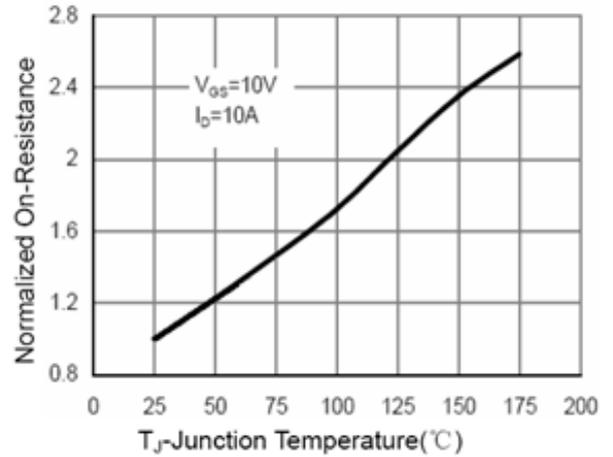


Figure 4 Rdson-Junction Temperature

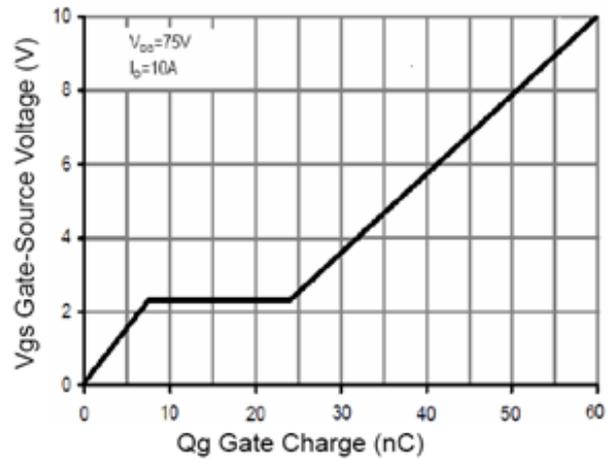


Figure 5 Gate Charge

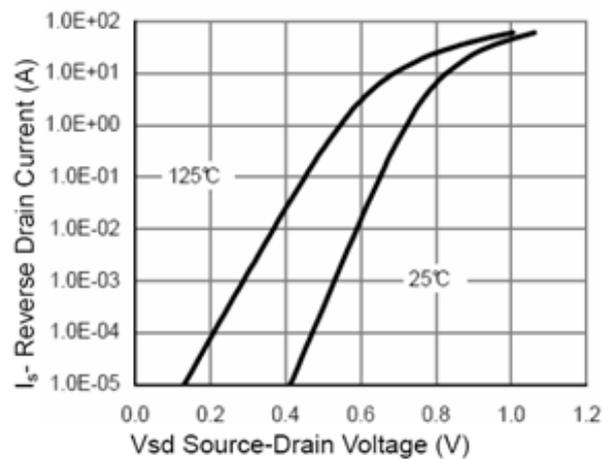
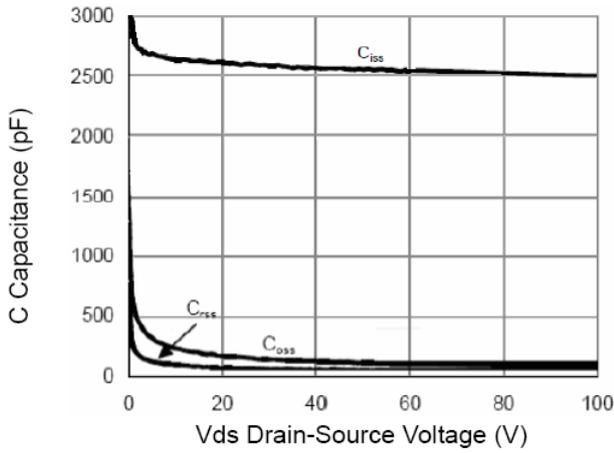


Figure 6 Source- Drain Diode Forward

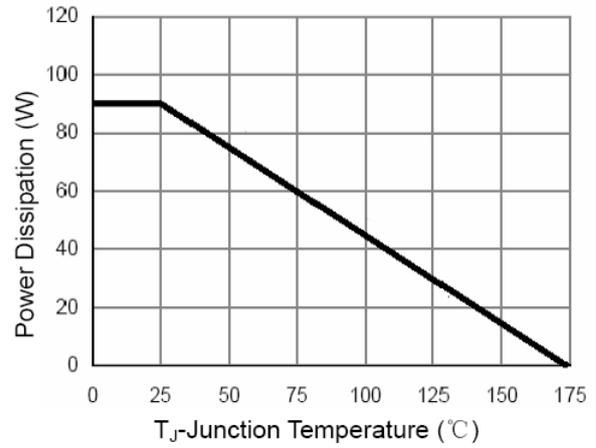


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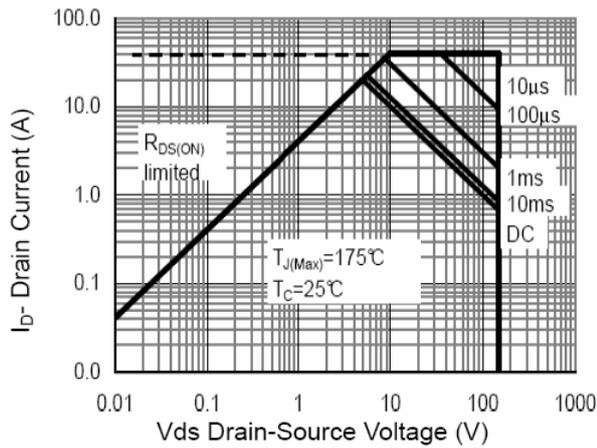
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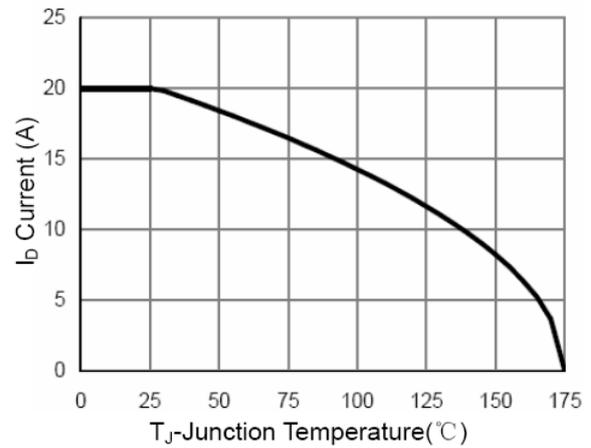
**Figure 7 Capacitance vs Vds**



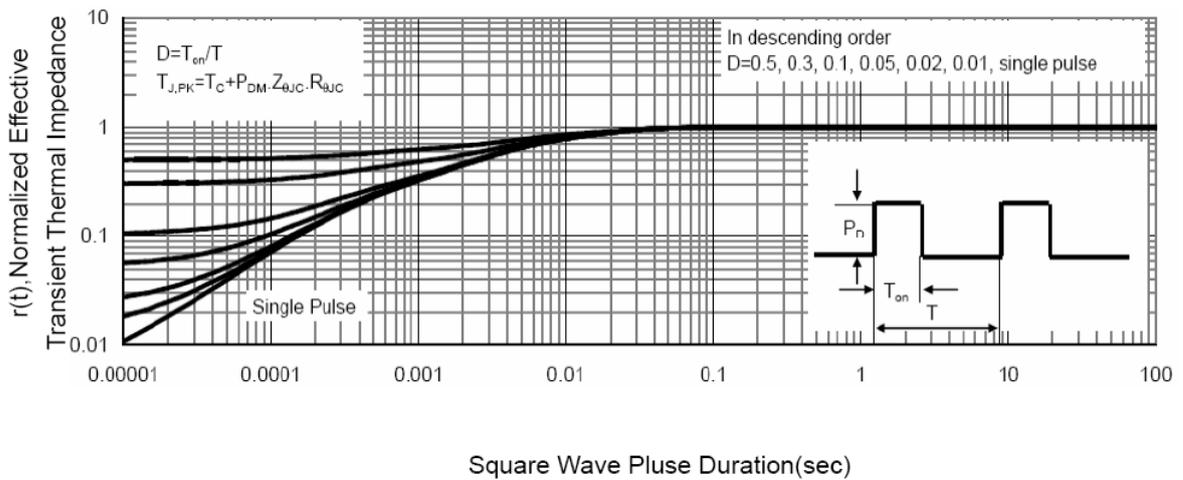
**Figure 9 Power De-rating**



**Figure 8 Safe Operation Area**



**Figure 10 Id Current- Junction Temperature**



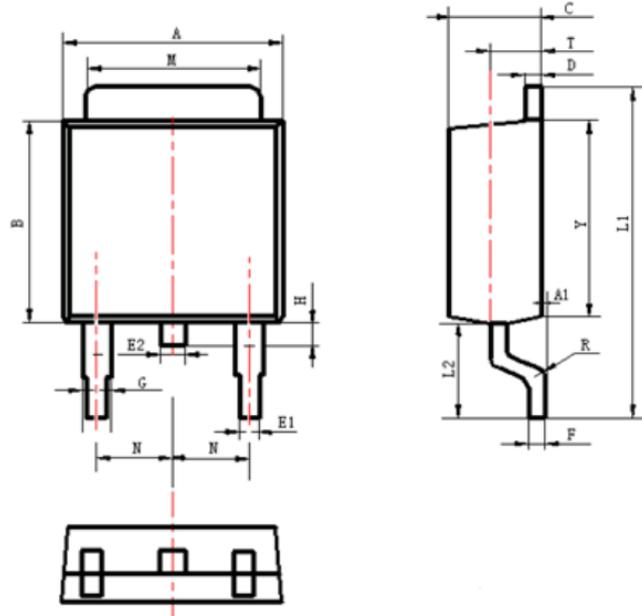
**Figure 11 Normalized Maximum Transient Thermal Impedance**



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## Package Information:



Items	Values(mm)	
	MIN	MAX
A	6.30	6.90
A1	0	0.16
B	5.70	6.30
C	2.10	2.50
D	0.30	0.70
E1	0.60	0.90
E2	0.70	1.00
F	0.30	0.60
G	0.70	1.20
L1	9.60	10.50
L2	2.70	3.10
H	0.40	1.00
M	5.10	5.50
N	2.09	2.49
R	0.3	
T	1.40	1.60
Y	5.10	6.30

TO-252 Package